

Static @ Tj = 25°C (unless otherwise specified)

Parameter	Min.	Typ.	Max.	Units	Conditions
Drain-to-Source Breakdown Voltage $V_{(BR)DSS}$	200	—	—	V	$V_{GS} = 0V, I_D = 1.0mA$
Static Drain to Source On-Resistance $R_{DS(on)}$	—	—	0.10 0.105	$\dot{\Omega}$	$V_{GS} = 10V, I_D = 17A$ $V_{GS} = 10V, I_D = 27.4A$
Gate Threshold Voltage V_{GS}	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
Drain-to-Source Leakage Current I_{DSS}	—	—	25	μA	$V_{DS} = 0.8 \times \text{Max rating}, V_{GS} = 0V$
	—	—	250		$V_{DS} = 0.8 \times \text{Max Rating}, V_{GS} = 0V,$ $T_J = 125^\circ C$
Gate-to-Source Forward Leakage I_{GSS}	—	—	100	nA	$V_{GS} = 20V$
Gate-to-Source Reverse Leakage I_{GSS}	—	—	-100		$V_{GS} = -20V$

Dynamic @ Tj = 25°C (unless otherwise specified)

Parameter	Min.	Typ.	Max.	Units	Conditions
Forward Transconductance g_{fs}	9	—	—	S	$V_{DS} = 15V, I_{DS} = 17A$
Total Gate Charge Q_g	55	—	115	nC	$I_D = 27.4A$ $V_{DS} = 0.5 \times \text{Max Rating}$ $V_{GS} = 10V$
Gate-to-Source Charge Q_{gs}	8	—	22		
Gate-to-Drain ("Miller") charge Q_{gd}	30	—	60		
Turn-on-Delay Time $t_{d(on)}$	—	—	35	ns	$V_{DD} = 100V$ $I_D = 27.4A$ $R_G = 2.35 \text{ ohms}$
Rise Time t_r	—	—	190		
Turn-Off-Delay Time $t_{d(off)}$	—	—	170		
Fall time t_f	—	—	130		
Input Capacitance C_{iss}	—	3500	—	μF	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1.0 \text{ MHz}$
Output Capacitance C_{oss}	—	700	—		
Reverse Transfer Capacitance C_{rss}	—	110	—		
Drain to Case Capacitance C_{DC}	—	12	—		
Internal Drain Inductance L_D	—	8.7	—	nH	Measured from drain lead, 6mm from package to center of die.
Internal Source Inductance L_S	—	8.7	—		

Avalanche Characteristics

Parameter		Typ.	Max.	Units
Single Pulse Avalanche Energy	E_{AS}	—	500	mJ
Avalanche Current	I_{AR}	—	27.4	A
Repetitive Avalanche Energy	E_{AR}	—	15	mJ

Thermal Resistance

Parameter		Typ.	Max.	Units
Junction-to-case	$R_{\theta JC}$	—	0.83	°C/W
Case-to-Sink, flat, Greased Surface	$R_{\theta CS}$	0.21	—	
Junction-to-ambient	$R_{\theta JA}$	—	48	

Diode Characteristics

Parameter		Min.	Typ.	Max.	Units	Conditions
Continuous Source Current	I_S	—	—	27.4	A	
Pulsed Source Current	I_{SM}	—	—	110		
Diode Forward Voltage	V_{SD}	—	—	1.9	V	$T_J = 25^\circ\text{C}$, $I_S = 27.4\text{A}$, $V_{GS} = 0\text{V}$
Reverse Recovery Time	t_{rr}	—	—	950	ns	$T_J = 25^\circ\text{C}$, $I_F = 27.4\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$ $V_{DD} = 50\text{V}$
Reverse Recovery Charge	Q_{rr}	—	—	9.0	uC	
Forward Turn-on Time	t_{on}	Intrinsic turn-on time is negligible				

Semitronics Corp.

64 Commercial Street, Freeport, NY 11520 • Phone (516) 623-9400 • Fax (516) 623-6954